

LEXANT™ VISUALFX™ RESIN FXM1414T

REGION ASIA

DESCRIPTION

PC-siloxane copolymer in special metallic colors. Medium flow. Improved toughness compared to medium flow standard PC in same color. Color package may affect performance.

TYPICAL PROPERTY VALUES

Revision 20230607

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
MECHANICAL ⁽¹⁾			
Tensile Stress, yld, Type I, 50 mm/min	58	MPa	ASTM D638
Tensile Stress, brk, Type I, 50 mm/min	48	MPa	ASTM D638
Tensile Strain, yld, Type I, 50 mm/min	5.7	%	ASTM D638
Tensile Strain, brk, Type I, 50 mm/min	78	%	ASTM D638
Tensile Modulus, 50 mm/min	2260	MPa	ASTM D638
Flexural Stress, yld, 1.3 mm/min, 50 mm span	85	MPa	ASTM D790
Flexural Modulus, 1.3 mm/min, 50 mm span	2230	MPa	ASTM D790
Tensile Stress, yield, 50 mm/min	56	MPa	ISO 527
Tensile Stress, break, 50 mm/min	47	MPa	ISO 527
Tensile Strain, yield, 50 mm/min	5.4	%	ISO 527
Tensile Strain, break, 50 mm/min	89	%	ISO 527
Tensile Modulus, 1 mm/min	2270	MPa	ISO 527
Flexural Stress, yield, 2 mm/min	88	MPa	ISO 178
Flexural Modulus, 2 mm/min	2120	MPa	ISO 178
IMPACT ⁽¹⁾			
Izod Impact, notched, 23°C	520	J/m	ASTM D256
Izod Impact, notched, -30°C	270	J/m	ASTM D256
Instrumented Dart Impact Total Energy, 23°C	57	J	ASTM D3763
Izod Impact, notched 80*10*4 +23°C	30	kJ/m ²	ISO 180/1A
Izod Impact, notched 80*10*4 -30°C	14	kJ/m ²	ISO 180/1A
Charpy 23°C, V-notch Edgew 80*10*4 sp=62mm	40	kJ/m ²	ISO 179/1eA
THERMAL ⁽¹⁾			
Vicat Softening Temp, Rate B/50	139	°C	ASTM D1525
HDT, 1.82 MPa, 3.2mm, unannealed	120	°C	ASTM D648
CTE, -40°C to 95°C, flow	6.75E-05	1/°C	ASTM E831
CTE, -40°C to 95°C, xflow	8.E-05	1/°C	ASTM E831
CTE, 23°C to 80°C, flow	6.75E-05	1/°C	ISO 11359-2
CTE, 23°C to 80°C, xflow	8.E-05	1/°C	ISO 11359-2
Ball Pressure Test, 75°C +/- 2°C	PASS	-	IEC 60695-10-2
Vicat Softening Temp, Rate B/50	138	°C	ISO 306
Vicat Softening Temp, Rate B/120	142	°C	ISO 306
HDT/Af, 1.8 MPa Flatw 80*10*4 sp=64mm	119	°C	ISO 75/Af
Relative Temp Index, Elec ⁽²⁾	80	°C	UL 746B
Relative Temp Index, Mech w/impact ⁽²⁾	80	°C	UL 746B

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CHEMISTRY THAT MATTERS™

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
Relative Temp Index, Mech w/o impact ⁽²⁾	80	°C	UL 746B
PHYSICAL ⁽¹⁾			
Specific Gravity	1.18	-	ASTM D792
Mold Shrinkage on Tensile Bar, flow ⁽³⁾	0.4 – 0.8	%	SABIC method
Mold Shrinkage, flow, 3.2 mm ⁽³⁾	0.4 – 0.8	%	SABIC method
Mold Shrinkage, xflow, 3.2 mm ⁽³⁾	0.4 – 0.8	%	SABIC method
Melt Flow Rate, 300°C/ 1.2 kgf	10	g/ 10 min	ASTM D1238
Density	1.18	g/cm ³	ISO 1183
Water Absorption, (23°C/saturated)	0.12	%	ISO 62-1
Moisture Absorption (23°C / 50% RH)	0.09	%	ISO 62
Melt Volume Rate, MVR at 300°C/ 1.2 kg	9	cm ³ /10 min	ISO 1133
ELECTRICAL ⁽¹⁾			
Comparative Tracking Index (UL) {PLC}	3	PLC Code	UL 746A
Hot-Wire Ignition (HWI), PLC 3	≥1.5	mm	UL 746A
High Amp Arc Ignition (HAI), PLC 0	≥3	mm	UL 746A
High Amp Arc Ignition (HAI), PLC 1	≥1.5	mm	UL 746A
FLAME CHARACTERISTICS ⁽²⁾			
UL Yellow Card Link	E207780-512794	-	-
UL Recognized, 94HB Flame Class Rating	≥1.5	mm	UL 94
Glow Wire Ignitability Temperature, 3.0 mm	850	°C	IEC 60695-2-13
Glow Wire Ignitability Temperature, 1.5 mm	825	°C	IEC 60695-2-13
Glow Wire Flammability Index, 3.0 mm	960	°C	IEC 60695-2-12
Glow Wire Flammability Index, 1.5 mm	800	°C	IEC 60695-2-12
INJECTION MOLDING ⁽⁴⁾			
Drying Temperature	120	°C	
Drying Time	3 – 4	Hrs	
Drying Time (Cumulative)	48	Hrs	
Maximum Moisture Content	0.02	%	
Melt Temperature	295 – 315	°C	
Nozzle Temperature	290 – 310	°C	
Front - Zone 3 Temperature	295 – 315	°C	
Middle - Zone 2 Temperature	280 – 305	°C	
Rear - Zone 1 Temperature	270 – 295	°C	
Mold Temperature	70 – 95	°C	
Back Pressure	0.3 – 0.7	MPa	
Screw Speed	40 – 70	rpm	
Shot to Cylinder Size	40 – 60	%	
Vent Depth	0.025 – 0.076	mm	

(1) The information stated on Technical Datasheets should be used as indicative only for material selection purposes and not be utilized as specification or used for part or tool design.

(2) UL Ratings shown on the technical datasheet might not cover the full range of thicknesses and colors. For details, please see the UL Yellow Card.

(3) Measurements made from laboratory test coupon. Actual shrinkage may vary outside of range due to differences in processing conditions, equipment, part geometry and tool design. It is recommended that mold shrinkage studies be performed with surrogate or legacy tooling prior to cutting tools for new molded article. The information stated on Technical Datasheets should be used as indicative only for material selection purposes and not be utilized as specification or used for part or tool design.

(4) Injection Molding parameters are only mentioned as general guidelines. These may not apply or may need adjustment in specific situations such as low shot sizes, large part molding, thin wall molding and gas-assist molding.

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ADDITIONAL PRODUCT NOTES

No PFAS intentionally added: The grade listed in this document does not contain PFAS intentionally added during Seller's manufacturing process and is not expected to contain unintentional PFAS impurities. Each user is responsible for evaluating the presence of unintentional PFAS impurities.

MORE INFORMATION

For curve data and CAE cards, please visit and register at <https://materialfinder.sabic-specialties.com>

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